

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT6259003

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
DEFOND ELECTRICAL INDUSTRIES LIMITED	06/01/2017
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	DEFOND COMPONENTS LIMITED
<b>Street Address:</b>	5/F, CHAI WAN INDUSTRIAL CENTRE, 20 LEE CHUNG STREET
<b>City:</b>	CHAI WAN
<b>State/Country:</b>	HONG KONG
<b>Name:</b>	DONGGUAN CHEN DA APPLIANCE CO. LTD.
<b>Street Address:</b>	HONGMEI SECOND INDUSTRIAL AREA, HONGMEI TOWN, DONGGUAN
<b>City:</b>	GUANGDONG
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	523160
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Patent Number:</b>	10418195
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(503)972-9115
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	(503) 224-6655
<b>Email:</b>	mandi@khpatent.com
<b>Correspondent Name:</b>	DAVID P. COOPER / KOLISCH HARTWELL, P.C.
<b>Address Line 1:</b>	520 S.W. YAMHILL ST., SUITE 300
<b>Address Line 4:</b>	PORTLAND, OREGON 97204
<b>ATTORNEY DOCKET NUMBER:</b>	LST340
<b>NAME OF SUBMITTER:</b>	DAVID P. COOPER
<b>SIGNATURE:</b>	/ David P. Cooper /
<b>DATE SIGNED:</b>	08/19/2020
<b>Total Attachments: 7</b>	
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**PATENT**

**REEL: 053544 FRAME: 0689**

**Summary of Two Assignments Being Recorded August 19, 2020  
In Connection With U.S. Patent No. 10,418,195 (Serial No. 15/869,794)**

This is to clarify the record as to the chain of title from the inventor to the co-applicants of the above-identified U.S. patent by replacing the previously recorded assignments with the accompanying two assignments which are summarized below:

1. Before filing of the priority Hong Kong patent applications, the inventor assigned all rights to the invention, including to file patent applications covering them, to their employer Defond Electrical Industries Limited.
2. Thereafter, Defond Electrical Industries Limited assigned its rights to Defond Components Limited and Dongguan Chen Da Appliance Co. Ltd. (which later changed its name to Defond Electech Co., Ltd.).

**Confirmatory Assignment of Invention Rights and Rights to File Patent Application**

THIS CONFIRMATORY ASSIGNMENT having an effective date of 1 June 2017.

**PARTIES:**

The Assignor: DEFOND ELECTRICAL INDUSTRIES LIMITED of 5/F, Chai Wan Industrial Centre, 20 Lee Chung Street, Chai Wan, Hong Kong

The Assignees: 1. DEFOND COMPONENTS LIMITED of 5/F, Chai Wan Industrial Centre, 20 Lee Chung Street, Chai Wan, Hong Kong

and

2. DONGGUAN CHEN DA APPLIANCE CO. LTD of Hongmei Second Industrial Area, Hongmei Town, Dongguan, Guangdong 523160, China

Who together are referred to as the "Parties" and individually as the "Party".

**WHEREAS:**

- (A) The Assignor gained entitlement from the Inventor to the Invention described and claimed in Hong Kong Short-Term Patent Application No. 17105471.8 ("the patent application") titled "A CONTACT LEVER FOR USE IN AN ELECTRICAL SWITCH ASSEMBLY" ("the Invention") which was filed on 1 June 2017.
- (B) The Assignor confirms that prior to filing of the patent application, it agreed to assign to the Assignees as co-owners each having 50% equal share, and their successors, (i) full right and interest in the Invention, (ii) full right and title to the use of the Invention, (iii) full right, title, authorisation and entitlement to file the patent application and to apply for and obtain patents or other similar forms of protection in respect of the Invention throughout the world upon the terms and conditions set out below.

**OPERATIVE PROVISIONS:**

- 1. "Invention" shall mean the Invention as claimed by and as disclosed in the patent application.
- 2. In pursuance of the present Assignment and in consideration of the sum of HK\$100.00 (One-Hundred Hong Kong Dollars) paid by the Assignees to the Assignor (receipt and sufficiency of which the Assignor hereby acknowledges) the Assignor hereby confirms that the Assignor assigned to the Assignees:
  - 2.1. all rights, title and interest possessed by the Assignor in respect of the Invention;
  - 2.2. the full right to file the patent application and to apply for and obtain patents or other similar forms of protection in respect of the Invention throughout the world, including without limitation, the list of applications enclosed in Annexure A of this Assignment;

- 2.3. the right to claim priority from the patent application under the Paris Convention or under World Trade Organisation agreements, Patent Cooperation Treaty (PCT) when making applications in Paris Convention countries or territories, or when making applications in non-Paris Convention Countries, or national phase entries from any PCT patent applications.
3. The Assignor shall at the expense of the Assignees execute, sign and do all such instruments, applications, documents, acts and things as shall be necessary for assuring and registering the Assignees' title to the Invention and for evidencing the assignment of the rights hereunder to the Assignees.
4. In the event that the validity of any patent resulting from the Invention is opposed, the Assignor shall at the request and expense of the Assignees do all such acts and provide the Assignees with all information to which it has or can lawfully procure access and all assistance as is reasonable and lawful to assist in the defence of the validity of the patent and any opposition to the fullest extent in any proceedings and on any appeal therefrom.
5. The Parties hereby agree that this Assignment shall be governed by the laws of Hong Kong and submit to the non-exclusive jurisdiction of the Courts of Hong Kong.
6. This Agreement may be executed in counterparts, each of which together shall constitute one and the same instrument.

WITNESS of which this Assignment has been executed by the parties, with an effective date above.

SIGNED for and on behalf of  
the Assignor  
DEFOND ELECTRICAL INDUSTRIES  
LIMITED

  
\_\_\_\_\_  
TAK CHUEN RICHARD OR  
Title: CEO

SIGNED for and on behalf of  
the Assignee  
DONGGUAN CHEN DA APPLIANCE  
CO. LTD

  
\_\_\_\_\_  
TAK CHUEN RICHARD OR  
Title: CEO

SIGNED for and on behalf of  
the Assignee  
DEFOND COMPONENTS LIMITED

  
\_\_\_\_\_  
TAK CHUEN RICHARD OR  
Title: CEO

### **Annexure A**

First-Filing Priority Patent Applications, Basic Patent Applications, Provisional Patent Applications, Non-Provisional Patent Applications, International PCT Patent Applications, PCT National Phase Patent Applications, PCT Regional Phase Patent Applications, Paris Convention National Patent Applications, Paris Convention Regional Patent Applications, Divisional Patent Applications, Continuation Patent Applications, Continuation-in-Part Patent Applications, Patents of Addition, Improvement Patent Applications, Re-Registration Patent Applications, Re-Recordal Patent Applications, Utility Model Patent Applications, Design Patent Applications, Design Applications, Paris Convention National Design Applications, Paris Convention Regional Design Applications, Divisional Design Patent Applications, Continuation Design Patent Applications and Continuation-in-Part Design Patent Applications.

**Confirmatory Assignment of Invention Rights and Rights to File Patent Application**

THIS CONFIRMATORY ASSIGNMENT having an effective date of 19 September 2017.

**PARTIES:**

The Assignor: DEFOND ELECTRICAL INDUSTRIES LIMITED of 5/F, Chai Wan Industrial Centre, 20 Lee Chung Street, Chai Wan, Hong Kong

The Assignees: 1. DEFOND COMPONENTS LIMITED of 5/F, Chai Wan Industrial Centre, 20 Lee Chung Street, Chai Wan, Hong Kong

and

2. DONGGUAN CHEN DA APPLIANCE CO. LTD of Hongmei Second Industrial Area, Hongmei Town, Dongguan, Guangdong 523160, China

Who together are referred to as the "Parties" and individually as the "Party".

**WHEREAS:**

- (A) The Assignor gained entitlement from the Inventor to the Invention described and claimed in Hong Kong Short-Term Patent Application No. 17109512.1 ("the patent application") titled "A CONTACT LEVER FOR USE IN AN ELECTRICAL SWITCH ASSEMBLY" ("the Invention") which was filed on 19 September 2017.
- (B) The Assignor confirms that prior to filing of the patent application, it agreed to assign to the Assignees as co-owners each having 50% equal share, and their successors, (i) full right and interest in the Invention, (ii) full right and title to the use of the Invention, (iii) full right, title, authorisation and entitlement to file the patent application and to apply for and obtain patents or other similar forms of protection in respect of the Invention throughout the world upon the terms and conditions set out below.


**OPERATIVE PROVISIONS:**

- 1. "Invention" shall mean the Invention as claimed by and as disclosed in the patent application.
- 2. In pursuance of the present Assignment and in consideration of the sum of HK\$100.00 (One-Hundred Hong Kong Dollars) paid by the Assignees to the Assignor (receipt and sufficiency of which the Assignor hereby acknowledges) the Assignor hereby confirms that the Assignor assigned to the Assignees:
  - 2.1. all rights, title and interest possessed by the Assignor in respect of the Invention;
  - 2.2. the full right to file the patent application and to apply for and obtain patents or other similar forms of protection in respect of the Invention throughout the world, including without limitation, the list of applications enclosed in Annexure A of this Assignment;

- 2.3. the right to claim priority from the patent application under the Paris Convention or under World Trade Organisation agreements, Patent Cooperation Treaty (PCT) when making applications in Paris Convention countries or territories, or when making applications in non-Paris Convention Countries, or national phase entries from any PCT patent applications.
3. The Assignor shall at the expense of the Assignees execute, sign and do all such instruments, applications, documents, acts and things as shall be necessary for assuring and registering the Assignees' title to the Invention and for evidencing the assignment of the rights hereunder to the Assignees.
4. In the event that the validity of any patent resulting from the Invention is opposed, the Assignor shall at the request and expense of the Assignees do all such acts and provide the Assignees with all information to which it has or can lawfully procure access and all assistance as is reasonable and lawful to assist in the defence of the validity of the patent and any opposition to the fullest extent in any proceedings and on any appeal therefrom.
5. The Parties hereby agree that this Assignment shall be governed by the laws of Hong Kong and submit to the non-exclusive jurisdiction of the Courts of Hong Kong.
6. This Agreement may be executed in counterparts, each of which together shall constitute one and the same instrument.

WITNESS of which this Assignment has been executed by the parties, with an effective date above.

SIGNED for and on behalf of )  
the Assignor )  
**DEFOND ELECTRICAL INDUSTRIES** )  
**LIMITED** )

  
\_\_\_\_\_  
**TAK CHUEN RICHARD OR**  
Title: CEO

SIGNED for and on behalf of )  
the Assignee )  
**DONGGUAN CHEN DA APPLIANCE** )  
**CO. LTD** )

  
\_\_\_\_\_  
**TAK CHUEN RICHARD OR**  
Title: CEO

SIGNED for and on behalf of )  
the Assignee )  
**DEFOND COMPONENTS LIMITED** )

  
\_\_\_\_\_  
**TAK CHUEN RICHARD OR**  
Title: CEO



**Annexure A**

First-Filing Priority Patent Applications, Basic Patent Applications, Provisional Patent Applications, Non-Provisional Patent Applications, International PCT Patent Applications, PCT National Phase Patent Applications, PCT Regional Phase Patent Applications, Paris Convention National Patent Applications, Paris Convention Regional Patent Applications, Divisional Patent Applications, Continuation Patent Applications, Continuation-in-Part Patent Applications, Patents of Addition, Improvement Patent Applications, Re-Registration Patent Applications, Re-Recordal Patent Applications, Utility Model Patent Applications, Design Patent Applications, Design Applications, Paris Convention National Design Applications, Paris Convention Regional Design Applications, Divisional Design Patent Applications, Continuation Design Patent Applications and Continuation-in-Part Design Patent Applications.